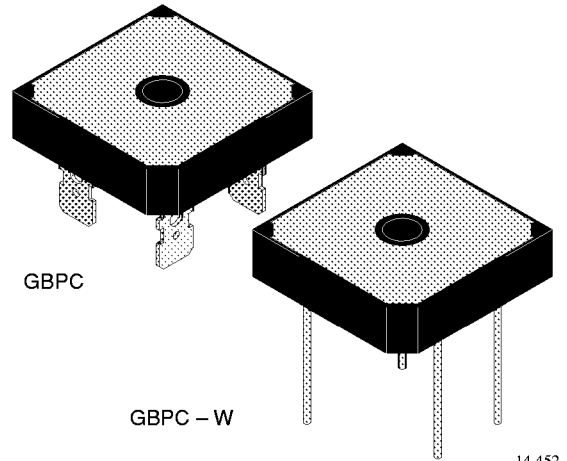




## 15A Glass Passivated Bridge Rectifier

### Features

- Glass passivated die construction
- Diffused junction
- Low reverse leakage current
- Low power loss, high efficiency
- Surge overload rating to 300A peak
- Electrically isolated metal base for maximum heat dissipation
- Case to terminal isolation voltage 2500V
- UL listed under recognized component index , file number E95060



14 452

### Absolute Maximum Ratings

$T_j = 25^\circ\text{C}$

Parameter	Test Conditions	Type	Symbol	Value	Unit
Repetitive peak reverse voltage =Working peak reverse voltage =DC Blocking voltage		GBPC15005/W	$V_{RRM}$ $=V_{RWM}$ $=V_R$	50	V
		GBPC1501/W		100	V
		GBPC1502/W		200	V
		GBPC1504/W		400	V
		GBPC1506/W		600	V
		GBPC1508/W		800	V
		GBPC1510/W		1000	V
Peak forward surge current			$I_{FSM}$	300	A
Average forward current	$T_C=70^\circ\text{C}$		$I_{FAV}$	15	A
Junction and storage temperature range			$T_j=T_{stg}$	-65...+150	$^\circ\text{C}$

### Electrical Characteristics

$T_j = 25^\circ\text{C}$

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Forward voltage	$I_F=7.5\text{A}$		$V_F$			1.1	V
Reverse current	$T_C=25^\circ\text{C}$		$I_R$			5	$\mu\text{A}$
	$T_C=125^\circ\text{C}$		$I_R$			500	$\mu\text{A}$
$I^2t$ Rating for fusing			$I^2t$			374	$\text{A}^2\text{s}$
Diode capacitance	$V_R=4\text{V}, f=1\text{MHz}$		$C_D$		300		pF
Thermal resistance junction to case	mounted on heatsink		$R_{thJC}$		5.3		K/W



### Characteristics ( $T_j = 25^\circ\text{C}$ unless otherwise specified)

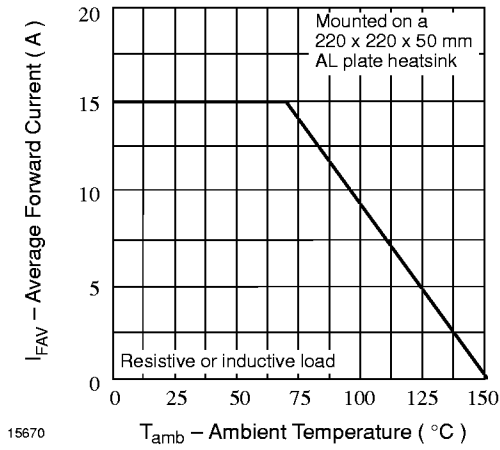


Figure 1. Max. Average Forward Current vs. Ambient Temperature

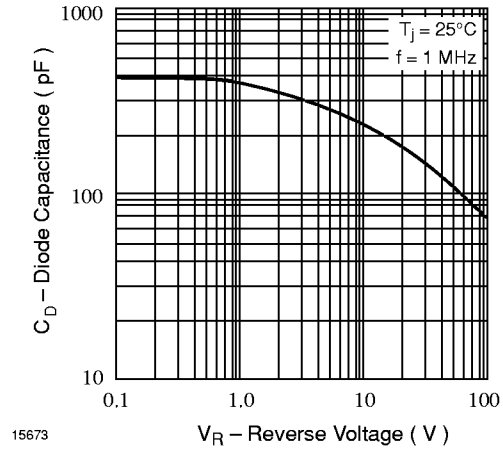


Figure 4. Typ. Diode Capacitance vs. Reverse Voltage

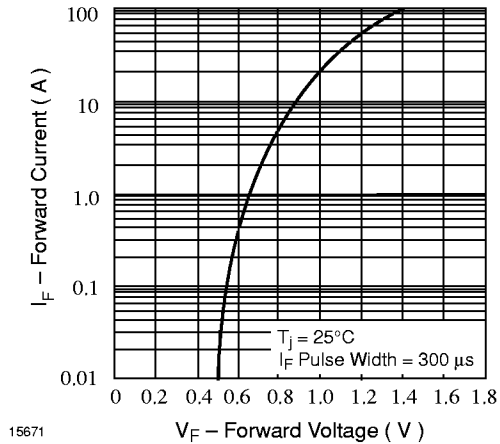


Figure 2. Typ. Forward Current vs. Forward Voltage

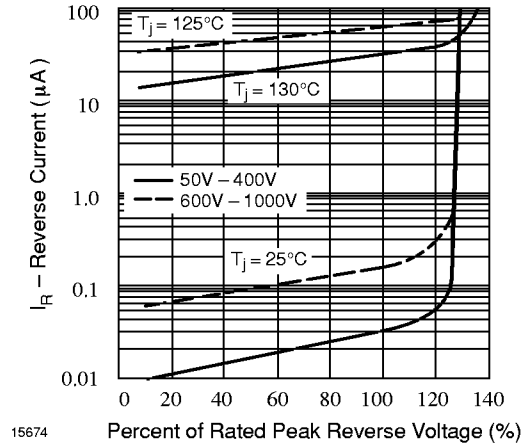


Figure 5. Typ. Reverse Current vs. Percent of Rated Peak Reverse Voltage

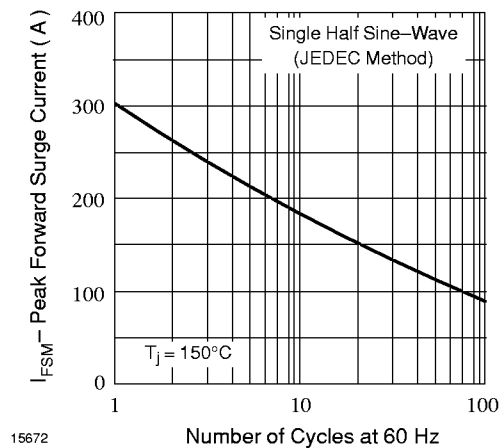


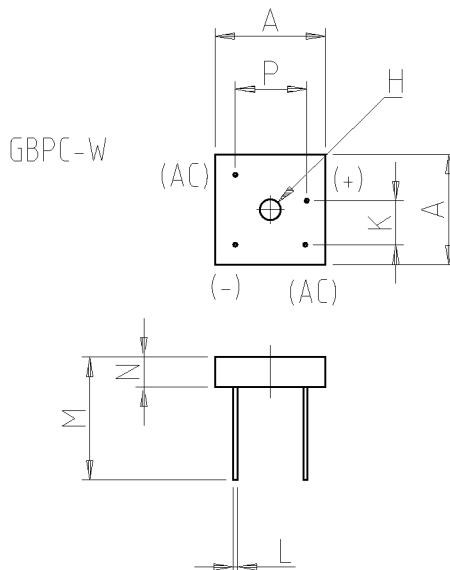
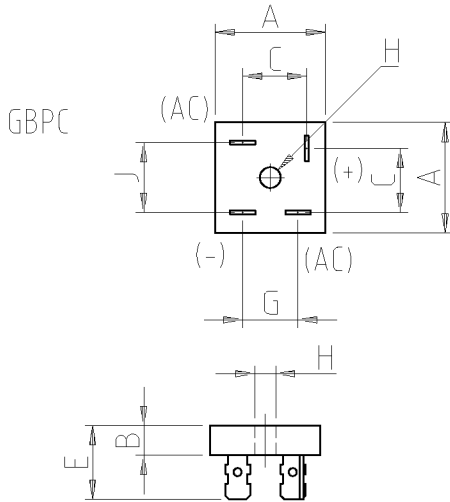
Figure 3. Max. Peak Forward Surge Current vs. Number of Cycles



# GBPC15005/W-GBPC1510/W

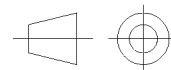
Vishay Lite-On Power Semiconductor

## Dimensions in mm



GBPC/GBPC-W		
Dim	Min	Max
A	28.30	28.80
B	7.40	8.00
C	16.10	17.10
E	18.80	21.30
G	13.80	14.80
H	Hole for #10 screw	
	∅5.08	∅5.59
J	17.60	18.60
K	10.90	11.90
L	∅0.97	∅1.07
M	31.80	-
N	7.40	8.00
P	17.60	18.60
All Dimensions in mm		

"W" Suffix Designates Wire Leads  
No Suffix Designates Faston Terminals



technical drawings  
according to DIN  
specifications

14477

Case: molded plastic  
Polarity: as marked on case  
Approx. weight: GBPC 18 grams,  
                    GBPC-W 14.5 grams  
Mounting: through hole for #10 screw  
Mounting torque: 8.0 Inch-pounds maximum  
Mounting position: any  
Marking: type number



### Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol ( 1987 ) and its London Amendments ( 1990 ) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**Vishay Semiconductor GmbH** has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**Vishay Semiconductor GmbH** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay-Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany  
Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423